

#### **Description**

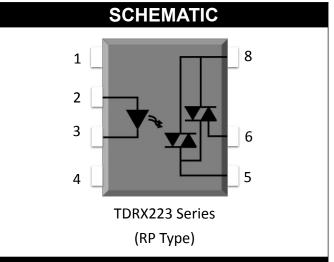
The TDRX223 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a monolithic silicon random-phase photo triac to drive a power triac in a plastic DIP7 package with different lead forming options.

#### **Features**

- High isolation 5000 VRMS
- DC input with triac output
- Operating temperature range 40 °C to 85 °C
- RoHS & REACH Compliance
- MSL class 1
- Regulatory Approvals
  - UL UL1577
  - VDE EN60747-5-5(VDE0884-5)
  - CQC GB4943.1, GB8898
  - cUL- CSA Component Acceptance
     Service Notice No. 5A

#### **Applications**

- Solenoid/valve controls
- Lighting controls
- Motor controls
- Temperature controls
- Static AC power switches
- Solid state relays
- Interfacing microprocessors to 115 to 240VAC peripherals



#### PIN DEFINITION

1. NC

8. Terminal

2. Anode

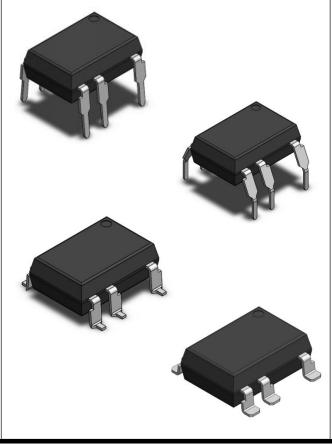
3. Cathode

6. Terminal

**4.** NC

5. Gate

#### **PACKAGE OUTLINE**





ABSOLUTE MAXIMUM RATINGS						
PARAMETER		SYMBOL	VALUE	UNIT	NOTE	
INPUT						
Forward Curr	ent	l <sub>F</sub>	60	mA		
Peak Forward C	Peak Forward Current		1	Α	1	
Reverse Volta	age	V <sub>R</sub>	6	V		
Junction Temperature		Tj	125	°C		
Input Power Diss	ipation	Pı	100	mW		
OUTPUT						
Off-state Output Term	inal Voltage	$V_{DRM}$	600	V		
	TDR0223		0.3	- A		
On-state RMS Current	TDR1223	IT <sub>(RMS)</sub>	0.6			
On-state Rivio Current	TDR2223	II (RMS)	0.9			
	TDR3223		1.2			
	TDR0223		3			
Non-repetitive Surge Current	TDR1223	I <sub>TSM</sub>	6	A		
PW=100µs, 120pps	TDR2223		9			
	TDR3223		12			
Junction Temperature		Tj	125	°C		
COMMON						
Total Power Dissipation		Ptot	400	mW		
Isolation Voltage		Viso	5000	Vrms	1	
Operating Temperature		Topr	-40~85	°C		
Storage Temperature		Tstg	-40~125	°C		
Soldering Temperature		Tsol	260	°C	2	

Note 1. 100μs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. =  $40 \sim 60\%$ 



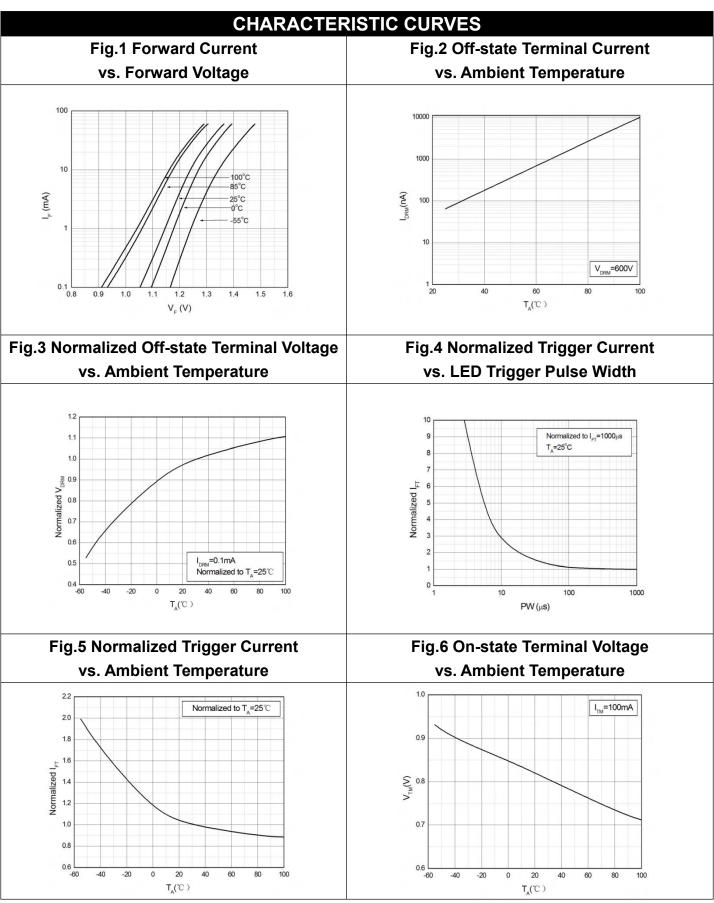
ELECTRICAL O	PTICA	L CH	ARA	CTE	RIS	TICS at Ta=25°C	
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT							
Forward Voltage	V <sub>F</sub>	-	1.24	1.4	V	I <sub>F</sub> =10mA	
Reverse Current	$I_R$	-	-	10	μA	V <sub>R</sub> =6V	
Input Capacitance	Cin	-	30	-	рF	V=0, f=1kHz	
OUTPUT							
Peak Off-state Current, Either Direction	I <sub>DRM</sub>	-	-	100	uA	V <sub>DRM</sub> =600V I <sub>F</sub> =0	
Peak On-state Current, Either Direction	V <sub>TM</sub>	-	0.8	2.5	٧	I <sub>TM</sub> = I <sub>TM</sub> Rated	
Critical Rate of Rise of Off-state Voltage Breakdown Voltage	dV/dt	1000	-	-	V	V <sub>PEAK</sub> =600V	3
TRANSFER CHARACTERISTICS							
LED Trigger Current	I <sub>FT</sub>	-	-	10	mA	Terminal Voltage = 6V RL=100 $\Omega$	
Holding Current Saturation Voltage	Ін	-	-	25	mA	-	
Isolation Resistance	Riso	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance	C <sub>IO</sub>	-	0.25	1	pF	V=0, f=1MHz	
ZERO CROSSING							

Note3. Test voltage must be applied within dV/dt rating.



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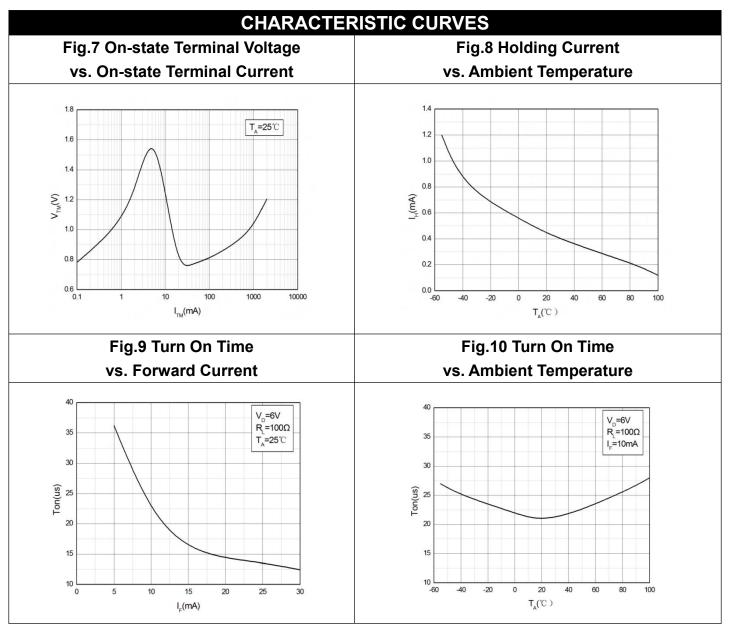
## DIP7, DC Input, TRIAC Output, Solid State Relay



Rev: A00

Release Date: 2024/08/29







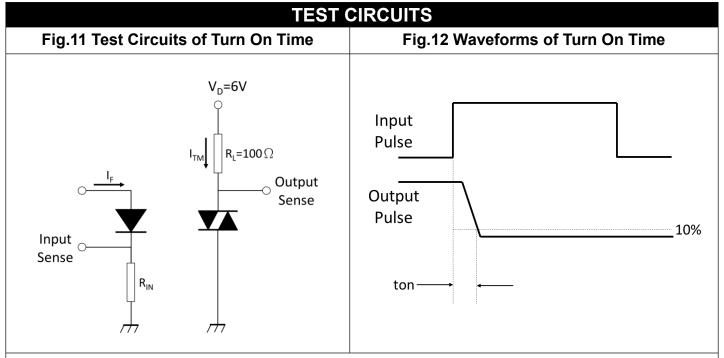


Fig.13 Test Circuits of dV/dt

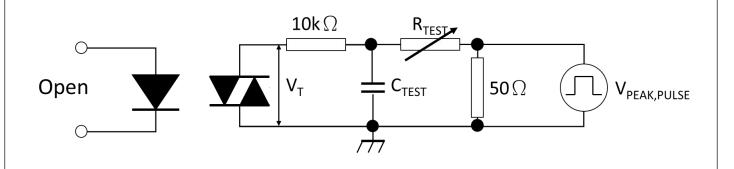
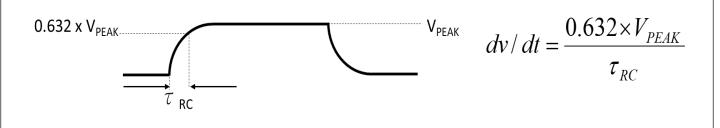
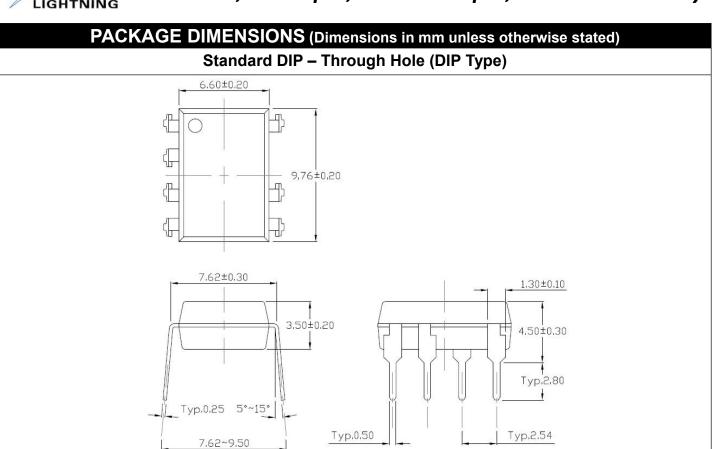


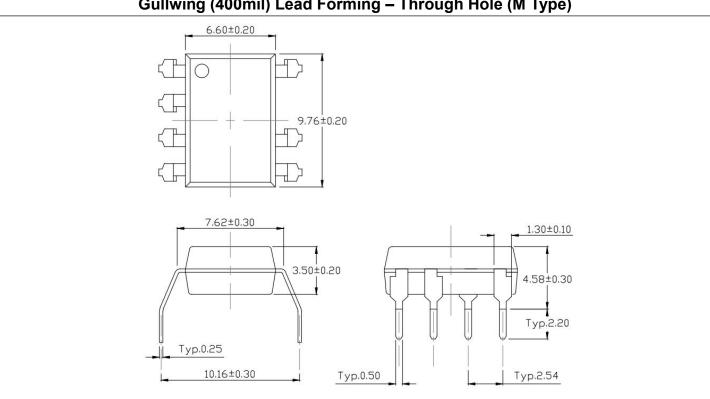
Fig.14 Waveforms of dV/dt







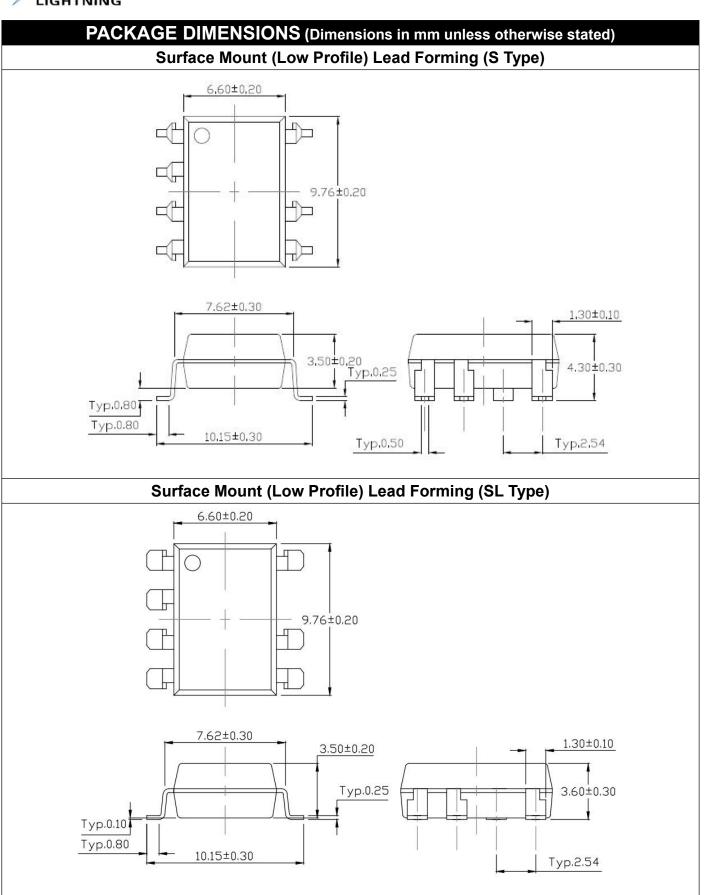
#### Gullwing (400mil) Lead Forming - Through Hole (M Type)





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## DIP7, DC Input, TRIAC Output, Solid State Relay

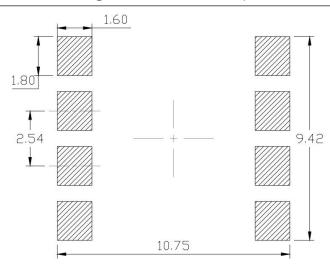


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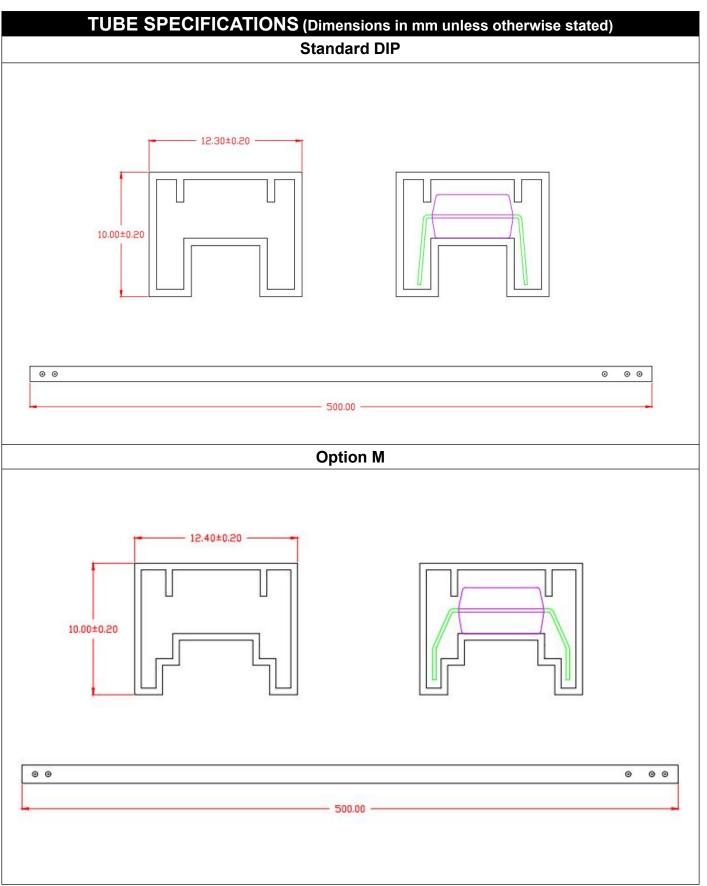


## Recommended Solder Mask (Dimensions in mm unless otherwise stated) Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming

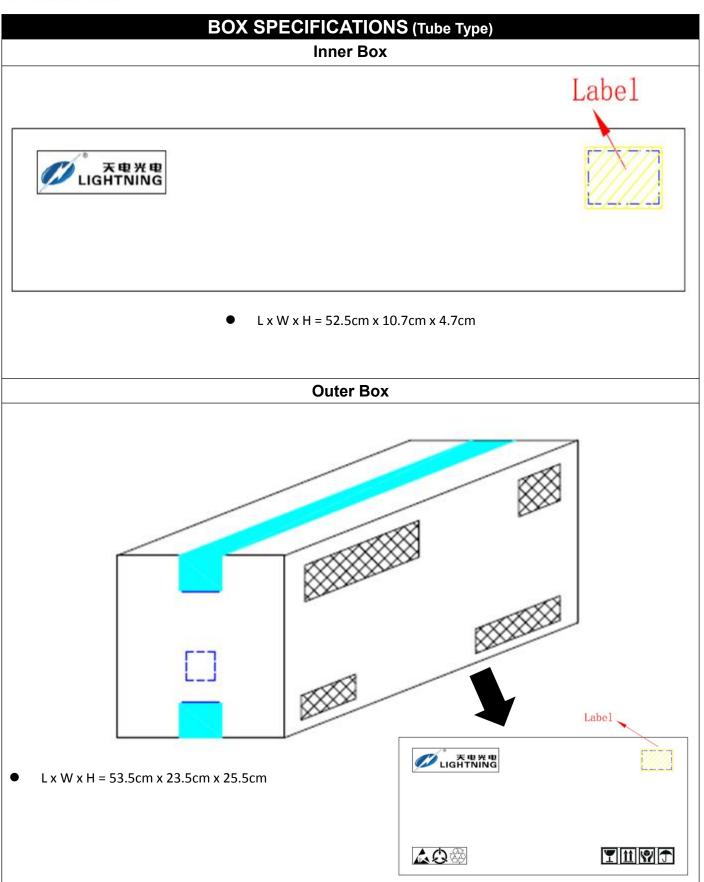




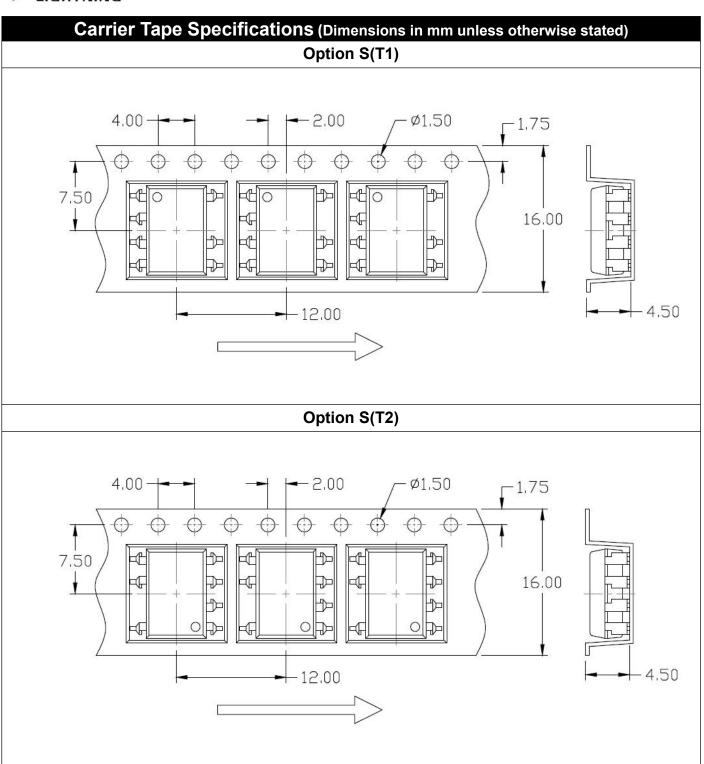
## TDRX223 Series DIP7, DC Input, TRIAC Output, Solid State Relay



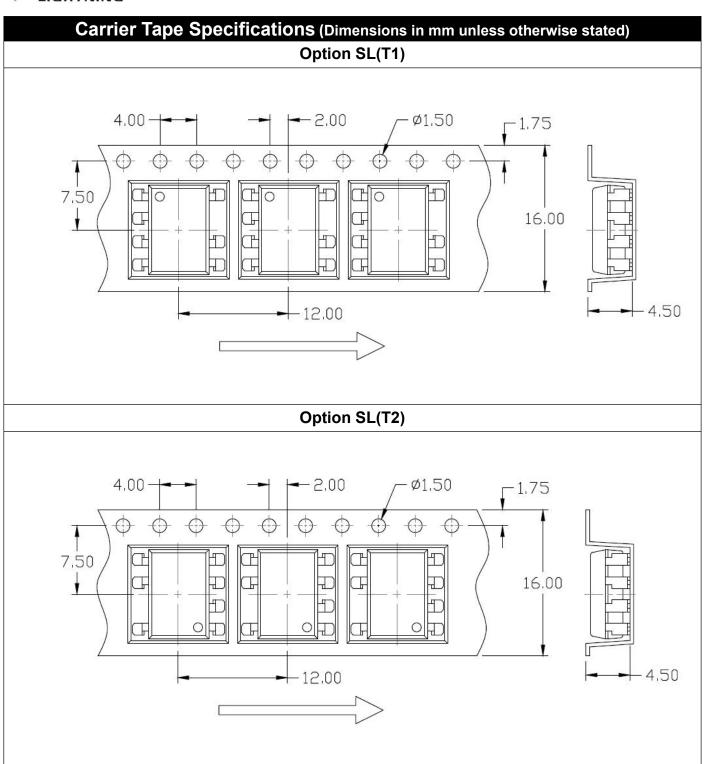




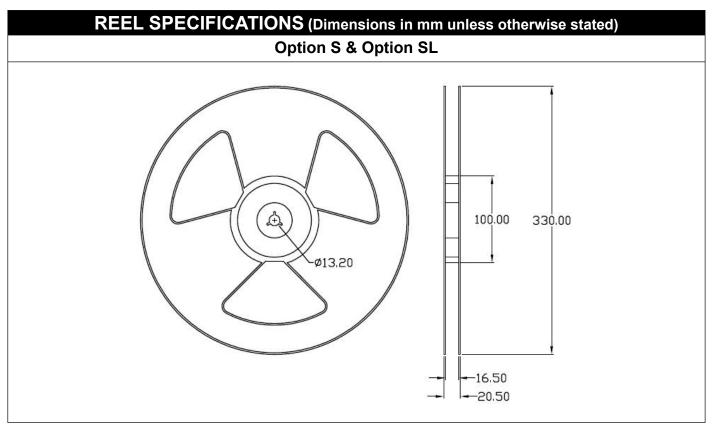




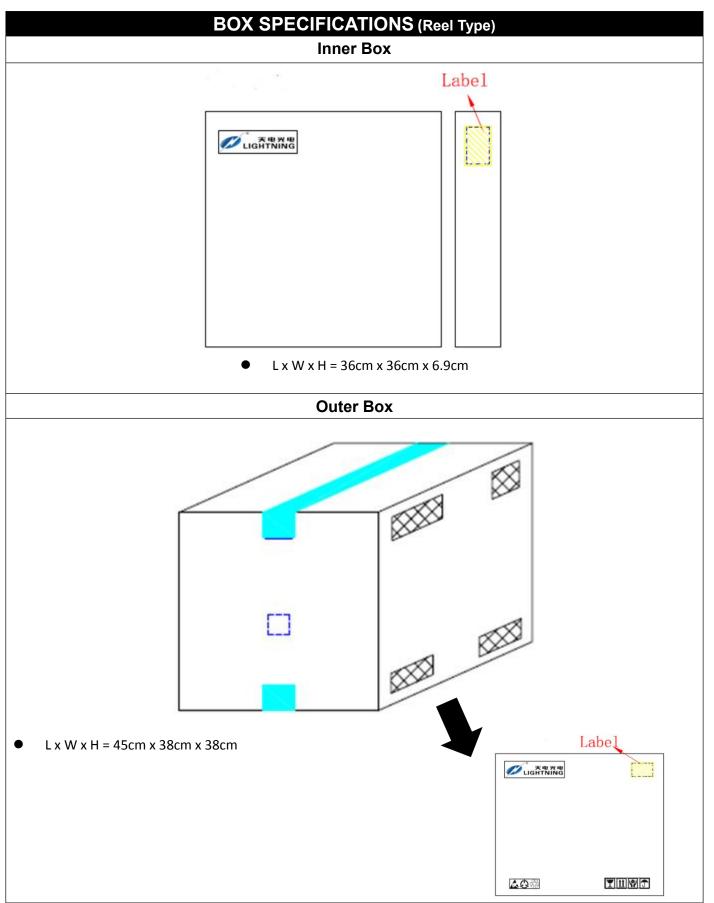








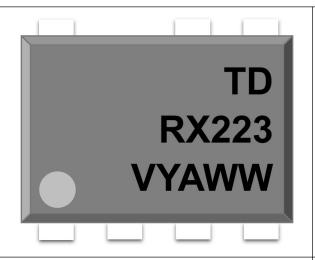






#### ORDERING AND MARKING INFORMATION

#### MARKING INFORMATION



: Company Abbr. TD

RX223 : Part Number & Rank

V : VDE Option Υ : Fiscal Year

: Manufacturing Code

ww : Work Week

#### ORDERING INFORMATION

#### **TDRX223(Y)(Z)-GV**

TD – Company Abbr.

RX223 – Part Number & Rank (X=0/1/2/3)

Y – Lead Form Option (M/SL/None)

Z – Tape and Reel Option (T1/T2)

G - Material Option

(G: Green, None: Non-Green)

V – VDE Option (V or None)

#### LABEL INFORMATION





Date Code: XXXX QTY: XXXX PCS









#### DACKING OHANTITY

PACKING QUANTITY					
Option	Quantity	Quantity – Inner box	Quantity – Outer box		
None	45 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 14.4k Units		
М	45 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 14.4k Units		
S(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
S(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SL(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SL(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		

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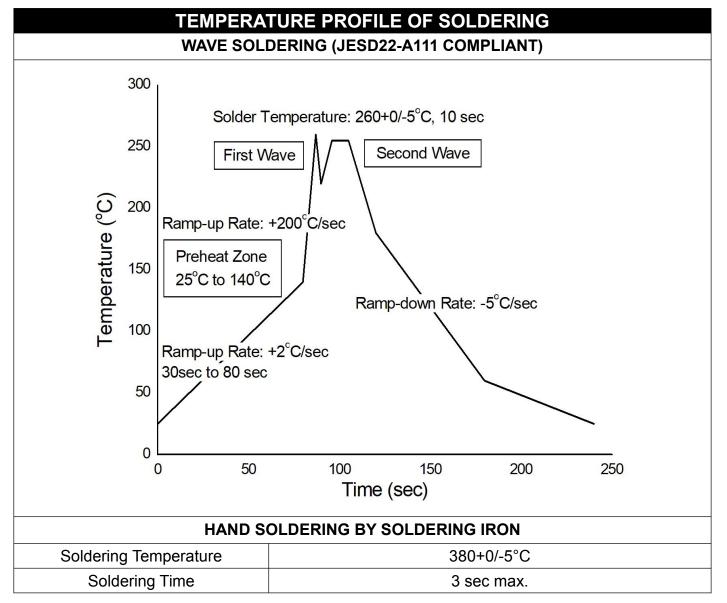


## DIP7, DC Input, TRIAC Output, Solid State Relay

## **REFLOW INFORMATION REFLOW PROFILE** Supplier T<sub>p</sub> ≥ T<sub>c</sub> User T<sub>p</sub> ≤ T<sub>c</sub> T<sub>C</sub> -5°C Supplier tp $T_p$ -T<sub>c</sub> -5°C Temperature 📑 Max. Ramp Up Rate = 3°C/s Max. Ramp Down Rate = 6°C/s $T_L$ $T_{smax}$ Preheat Area T<sub>smin</sub> 25 Time 25°C to Peak Time ⇒

Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) MainTained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.





- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



#### **DISCLAIMER**

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